CEM4954

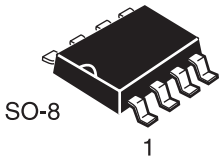
PRELIMINARY

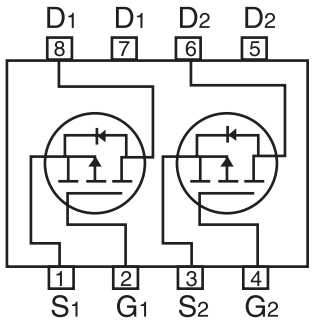
Dual P-Channel Enhancement Mode MOSFET

5

FEATURES

- -30V , -4.9A , $R_{DS(ON)}$=60mΩ @V_{GS}=-10V.
  -3.6A , $R_{DS(ON)}$=100mΩ @V_{GS}=-4.5V.
- Super high dense cell design for extremely low $R_{DS(ON)}$.
- High power and current handing capability.
- Surface Mount Package.





ABSOLUTE MAXIMUM RATINGS (T_A=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	±20	V
Drain Current-Continuous[a] @T_J=125°C	I_D	±4.9	A
-Pulsed[b]	I_{DM}	±30	A
Drain-Source Diode Forward Current[a]	I_S	-1.7	A
Maximum Power Dissipation[a]	P_D	2.0	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Ambient[a]	$R_{\theta JA}$	62.5	°C/W

ELECTRICAL CHARACTERISTICS (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ[c]	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V, I_D=-250μA	-30			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=-30V, V_{GS}=0V			-1	μA
Gate-Body Leakage	I_{GSS}	V_{GS}=±20V, V_{DS}=0V			±100	nA
ON CHARACTERISTICS[b]						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=-250μA	-1		-3	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS}=-10V, I_D=-4.9A			60	mΩ
		V_{GS}=-4.5V, I_D=-3.6A			100	mΩ
On-State Drain Current	$I_{D(ON)}$	V_{DS}=-5V, V_{GS}=-10V	-20			A
Forward Transconductance	g_{FS}	V_{DS}=-15V, I_D=-4.9A	5			S
DYNAMIC CHARACTERISTICS[c]						
Input Capacitance	C_{ISS}	V_{DS}=-15V, V_{GS}=0V, f=1.0MHz		860	1120	pF
Output Capacitance	C_{OSS}			457	600	pF
Reverse Transfer Capacitance	C_{RSS}			140	190	pF
SWITCHING CHARACTERISTICS[c]						
Turn-On Delay Time	$t_{D(ON)}$	V_D=-15V, R_L=15Ω, I_D=-1A, V_{GS}=-10V, R_{GEN}=6Ω		8	15	ns
Rise Time	t_r			12	20	ns
Turn-Off Delay Time	$t_{D(OFF)}$			23	40	ns
Fall Time	t_f			14	25	ns
Total Gate Charge	Q_g	V_{DS}=-15V, I_D=-4.9A, V_{GS}=-10V		16	25	nC
Gate-Source Charge	Q_{gs}			5		nC
Gate-Drain Charge	Q_{gd}			2		nC

CEM4954

ELECTRICAL CHARACTERISTICS (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ[c]	Max	Unit
DRAIN-SOURCE DIODE CHARACTERISTICS [b]						
Diode Forward Voltage	V_{SD}	V_{GS} = 0V, Is =-1.7A		-0.8	-1.2	V

Notes

a.Surface Mounted on FR4 Board, t ≤10sec.
b.Pulse Test:Pulse Width ≤300 μs, Duty Cycle ≤ 2%.
c.Guaranteed by design, not subject to production testing.

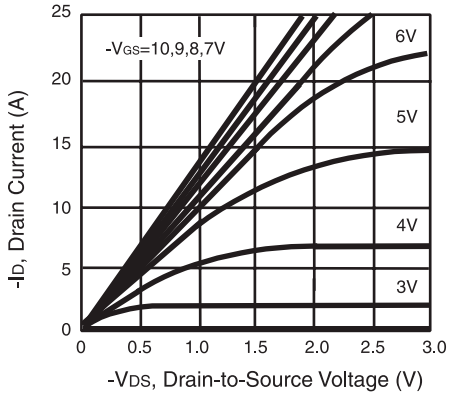


Figure 1. Output Characteristics

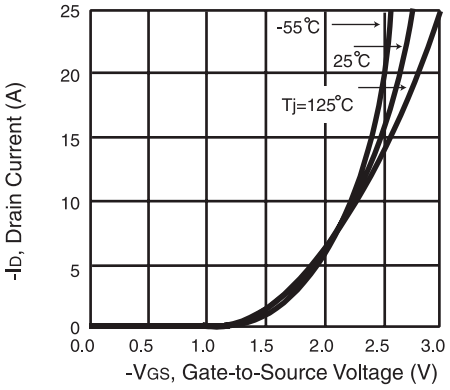


Figure 2. Transfer Characteristics

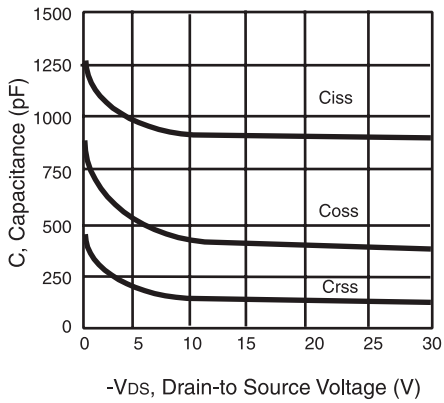


Figure 3. Capacitance

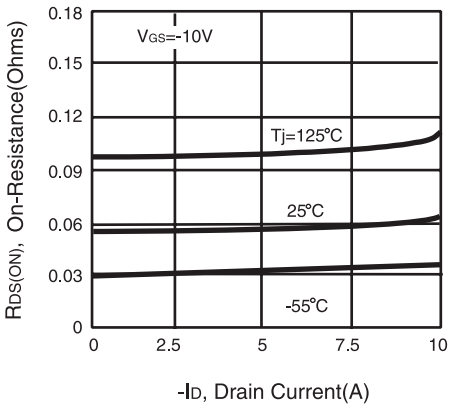


Figure 4. On-Resistance Variation with Drain Current and Temperature

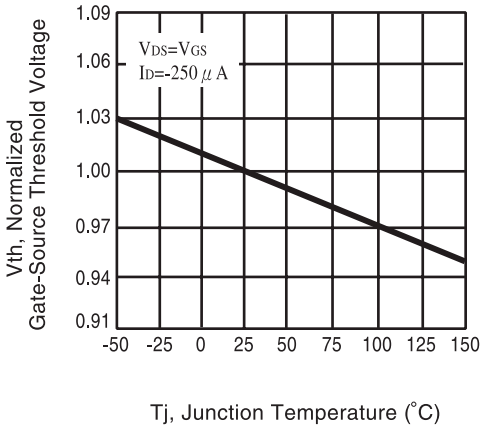


Figure 5. Gate Threshold Variation with Temperature

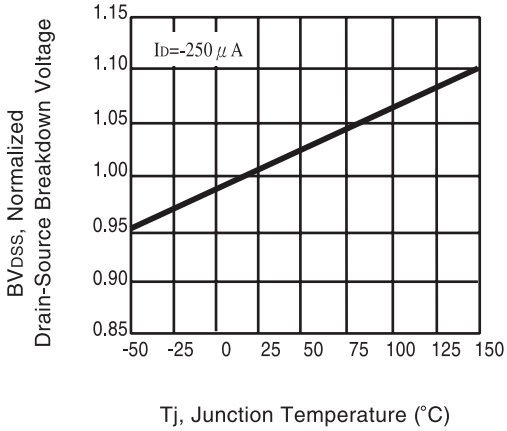


Figure 6. Breakdown Voltage Variation with Temperature

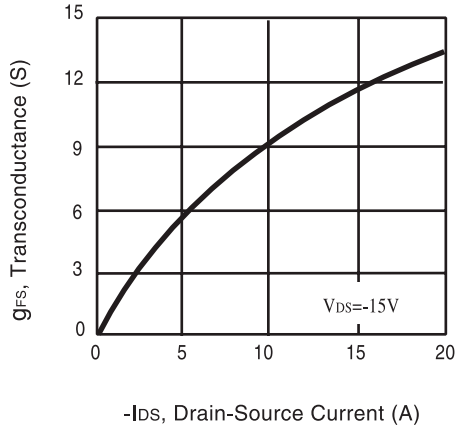


Figure 7. Transconductance Variation with Drain Current

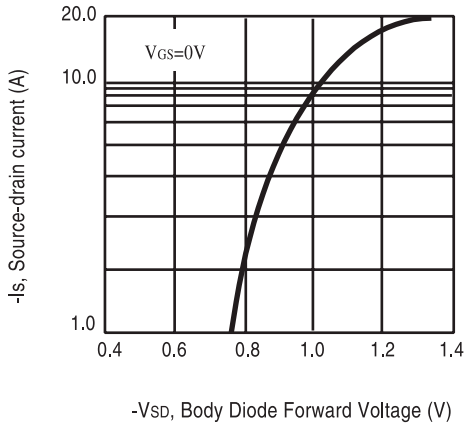


Figure 8. Body Diode Forward Voltage Variation with Source Current

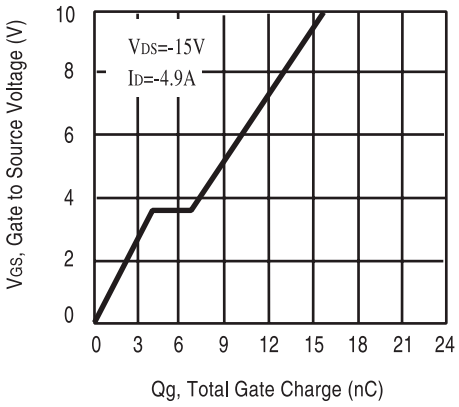


Figure 9. Gate Charge

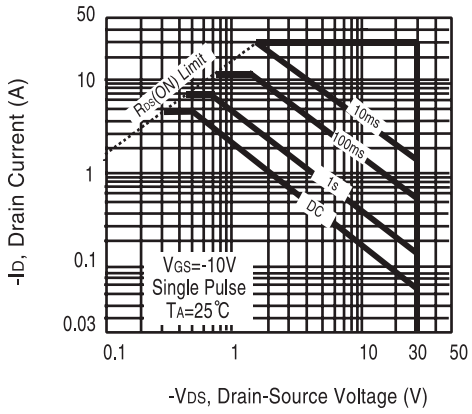


Figure 10. Maximum Safe Operating Area

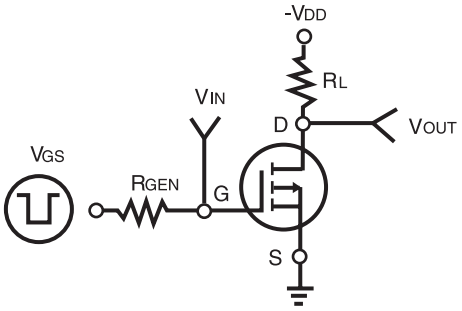


Figure 11. Switching Test Circuit

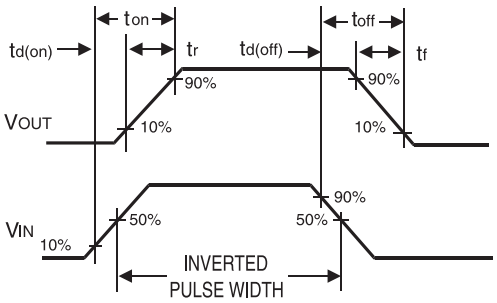


Figure 12. Switching Waveforms

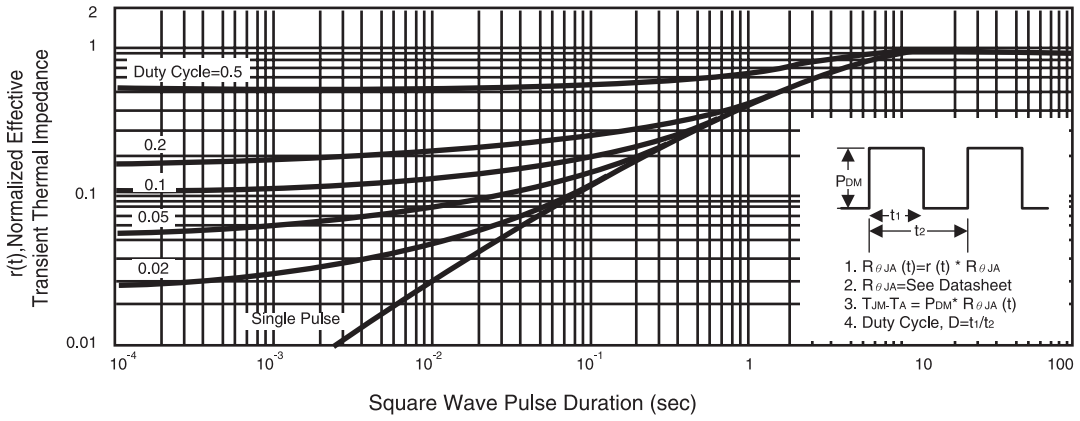


Figure 13. Normalized Thermal Transient Impedance Curve